

CRMCGH1505A

CGH1505A

XXX XXXXX

N-Channel 150V, 4.6mΩ Typ. Power MOSFET

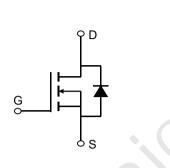
Description

Features

• 150V, 150A

 $R_{DS(ON)}$ Typ = 4.6m Ω @ V_{GS} = 10V

- Advanced Split Gate Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!



Schematic Diagram

Application

- Load Switch
- PWM Application
- Power Management

Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE (pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMCGH1505A	CRMCGH1505A	TO-220C-3L	TUBE	50	1000	5000

G D .

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		150	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	$T_{C} = 25^{\circ}C$	150	А
Ι _D		$T_{\rm C}$ = 100°C	90	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		600	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		756	mJ
P _D	Power Dissipation	$T_{C} = 25^{\circ}C$	272	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		0.46	°C/W
Τ _J , Τ _{STG}	Junction & Storage Temperature Range	•	-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{\rm D}$ = 250 μ A, $V_{\rm GS}$ = 0V	150	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 150V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2.5	3	3.5	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 30A	-	4.6	6	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	5030	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 75V, f = 1MHz	-	672	-	pF
C _{rss}	Reverse Transfer Capacitance		Χ-	15	-	pF
Q _g	Total Gate Charge	(_	80	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 75V$, $I_{D} = 20A$	J .	30	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 75 v, r_{\rm D} = 20 A$	-	15	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	50	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 75V	-	89	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 6 Ω	-	93	-	ns
t _f	Turn-Off Fall Time		-	58	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	150	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	600	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time		-	120	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	250	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=55A

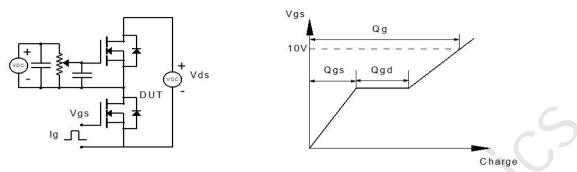
4. Pulse Test: Pulse Width \leqslant 300µs, Duty Cycle \leqslant 0.5%.

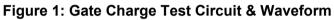


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Test Circuit





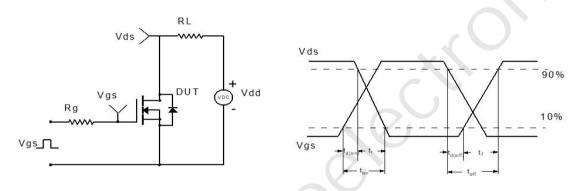
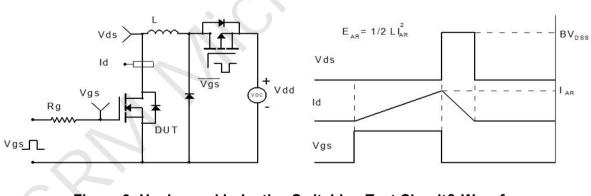


Figure 2: Resistive Switching Test Circuit & Waveform





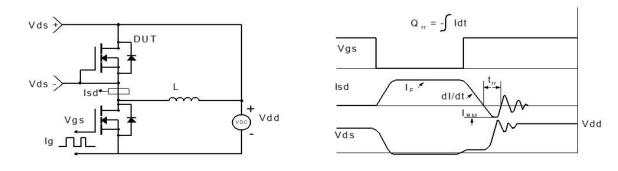
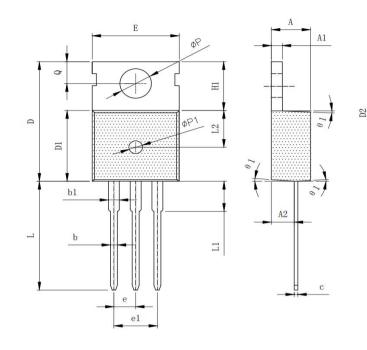


Figure 4: Diode Recovery Test Circuit & Waveform



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Package Mechanical Data(TO-220C-3L)



SYMBOL	MILLIMETER				
SIMDUL	MIN	NOM	MAX		
A	4.40	4.50	4.60		
A1	1.25	1.30	1.35		
A2	2.30	2.40	2.50		
b	0.70	0.80	0.90		
b1	1.25	1.35	1.45		
с	0.40	0.50	0.60		
D	15.50	15.80	16.10		
D1	9.10	9.20	9.30		
D2	12.73	12.83	12.93		
Е	9.70	9. 90	10.20		
E1	7.60	8.00	8.40		
е	2.54 (BSC) 5.08 (BSC)				
el 🔍					
H1	6. 30	6.50	6.80		
L	12. 75	13.08	13. 50		
Lì	_	()	3.10		
L2	4.30	4.60	4.90		
ØP	3. 50	3.60	3.70		
ØP1	1.40	1.50	1.60		
۵	2.70	1-21	2.90		
01	2°	4°	6°		

NOTES:1. PKG SURFACE IS MATTE Ral. 2[~]1.4; OTHERS IS POLISHED Ra0. 15;

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